



SAP Blended Learning Academy – Course Dates 2021

WS4HMM – Procurement in SAP S/4HANA (MM)

PUBLIC

SAP Blended Learning Academy

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Schedule	Kick Off	Review 1	Review 2	Review 3	Review 4	Region	Timezone	Language
1	08.03.21	15.04.21	20.05.21	24.06.21	27.07.21	DACH	CET, Berlin	German*
2	19.04.21	27.05.21	01.07.21	05.08.21	09.09.21	Americas	EST, Boston	English
3	03.05.21	10.06.21	08.07.21	12.08.21	16.09.21	EMEEA	CET, Brüssels	English
4	21.06.21	29.07.21	02.09.21	30.09.21	09.11.21	DACH	CET, Berlin	German*
5	05.07.21	03.08.21	07.09.21	14.10.21	16.11.21	APJ	IST, India	English
6	27.09.21	11.11.21	16.12.21	18.01.22	22.02.22	DACH	CET, Berlin	German*
7	04.10.21	04.11.21	07.12.21	13.01.22	17.02.22	Americas	EST, Boston	English
8	18.10.21	18.11.21	21.12.21	27.01.22	03.03.22	EMEEA	CET, Brüssels	English
9	29.11.21	11.01.22	15.02.22	15.03.22	12.04.22	APJ	IST, India	English
10	13.12.21	20.01.22	24.02.22	31.03.22	05.05.22	DACH	CET, Berlin	German*

*Live sessions in German language/Training material partly in English

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